

| | Type | L # | Hits | Search Text | DBs | Time Stamp |
|---|------|-----|------|--|--|---------------------|
| 1 | BRS | L1 | 244 | wafer and substrate and interposer and via | USPAT; US-PGP UB; EPO; JPO; DEFWEN T; IBM_TD B | 2002/02/12 10:33 |
| 2 | BRS | L2 | 147 | 1 and @ay<1999 | USPAT; US-PGP UB; EPO; JPO; DEFWEN T; IBM_TD B | 2002/02/12 09:46 |
| 3 | BRS | L3 | 218 | wafer and substrate and interposer and via and (dic\$3 separat\$3 cut singulate) | USPAT; US-PGP UB; EPO; JPO; DEFWEN T; IBM_TD B | 2002/02/12 10:43 |
| 4 | BRS | L4 | 137 | 3 and @ay<1999 | USPAT; US-PGP UB; EPO; JPO; DEFWEN T; IBM_TD B | 2002/02/12 10:41 |
| 5 | BRS | L5 | 136 | wafer and substrate and interconnect and via and (dic\$3 separat\$3 cut | USPAT; US-PGP UB; EPO; JPO; DEFWEN | 2002/02/12 11:01 |

| | Type | L # | Hits | Search Text | DBs | Time Stamp |
|---|------|-----|------|--|--|---------------------|
| 6 | BFS | L6 | 3440 | 5 and @ay<1999 | USPAT; US-PGP UB; EPO; JPO; DEFWEN T; IBM_TD B | 2002/02/12 10:49 |
| 7 | BFS | L7 | 688 | 6 and @ay>1997 | USPAT; US-PGP UB; EPO; JPO; DEFWEN T; IBM_TD B | 2002/02/12 10:49 |
| 8 | BFS | L10 | 654 | wafer and substrate and interconnect and via and (dic\$3 separat\$3 cut singulate) and @ad<19980320 and @ay>1996 | USPAT; US-PGP UB; EPO; JPO; DEFWEN T; IBM_TD B | 2002/02/12 11:22 |
| 9 | BFS | L11 | 11 | 10 and farnworth.in. | USPAT; US-PGP UB; EPO; JPO; DEFWEN T; IBM_TD B | 2002/02/12 11:23 |